

# **3-ELECTRODE GAS DISCHARGE TUBE (GDT)**

## **DESCRIPTION:**



The ALPDC0800-S05-00 is Gas Discharge Tube (GDT) is non-radioactive, Low capacitance ( $\leq$ 1.0pF) with high insulation resistance used for Communication industry and Signal Protection.

FEATURES:	APPLICATIONS:			
> Features non-radioactive	Communication industry			
> SMD type	Video surveillance			
➤ Low capacitance (≤1.0pF)	Outdoor lighting igniter			
High insulation resistance	Signal line protection			
> Size 8.3X8.3x16.0	<ul><li>Signal line protection</li></ul>			
Storage and operating temperature: -40°C ~ +85°C				
Material: RoHS compliant	Civil circuit appliances			

## **ORDERING PART NUMBER**

PART NUMBER	ORDERING PART NUMBER
ALPDC0800-S05-00	ALPDC0800-S05-00-LT



# **TYPICAL DEVICE CHARACTERISTICS**

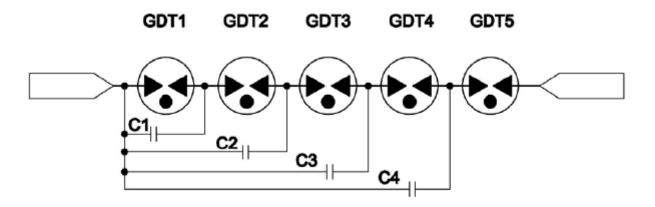
ELECTRICAL CHARACTERISTICS					
PARAMETER	VALUES	UNIT			
DC breakdown voltage (Note 1 & 2)	600-1000	V			
100V/s (Pin1-6)	000 1000	·			
DC breakdown voltage (Note 1 & 2)	120-200	V			
100V/s (Pin1-2, Pin2-3, Pin3-4, Pin4-5, Pin5-6)					
Impulse spark-over voltage <sup>(Note 3)</sup> at 1.2/50μs,6KV/3KA (Pin1-6)	≤2800	V			
Impulse spark-over voltage <sup>(Note 3)</sup> at 1.2/50μs,6KV/3KA (Pin1-2, Pin2-3, Pin3-4, Pin4-5, Pin5-6)	≤750	V			
Insulation resistance at DC 100V (Pin1-6)	≥1	GΩ			
Capacitance at 1MHz (Note 2)  V <sub>dc</sub> =0.5V (Pin1-6)	≤1	pF			
Service life					
10 operations [5× (+) & 5× (–)] 8/20 μs	20	KA			
10 operations [5× (+) & 5× (–)] 10/350 μs	4	KA			
300 operations (+/– alternating polarity) 10/1000 μs 100 A					
Arc Voltage At 1A	~60	V			
Maximum DC Working voltage	60	V			
Weight	~6.2	g			
Storage and operations temperature	-40 ~ +90	°C			
Marking, Blue	No Marking				

#### **NOTES:**

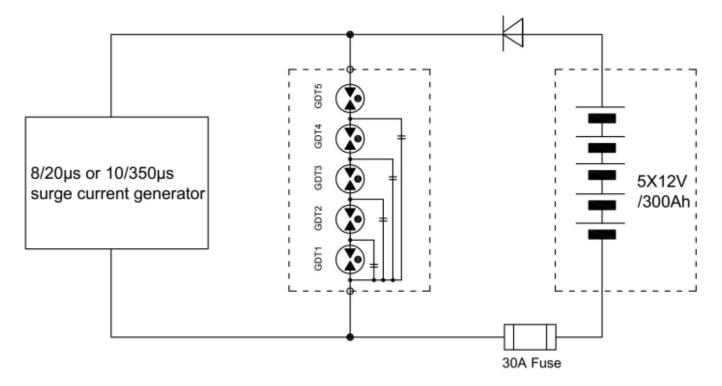
- 1) Terms in accordance with ITU-T K.12 and GB/T 9043-2008
- 2) At delivery AQL 0.65 level II, DIN ISO 2859
- 3) With 100PF capacitor trigger ,DC spark-over voltage (Pin1-6) 600v-1500v after load , Impulse spark-over voltage1.2/50µs,6KV/3KA (Pin1-2, Pin2-3, Pin3-4, Pin4-5, Pin5-6) ≤900v, (Pin1-6) ≤3300v.



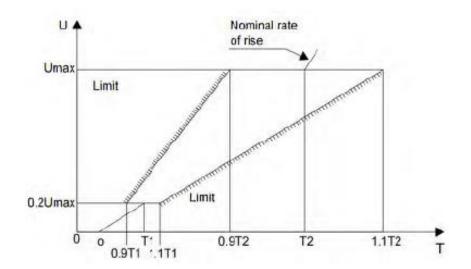
# CIRCUIT DIAGRAM (C1 to C4 = each capacitor 100 pF to 470 pF)



# Test circuit 10/350 µs or 8/20 µs circuit



# **DC BREAKDOWN VOLTAGE**



8/20μs, Test wave

10/700μs, Test wave

10/1000μs, Test wave

T1=1.25T=8µs±20%

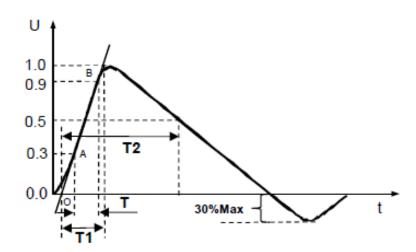
T1=1.67T=10µs±20%

T1=1.67T=10µs±20%

T2=20µs±20%

T2=700µs±20%

T2=1000µs±20%





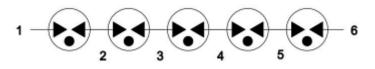
ALPDC0800-S05-00 (GDT)

# **PINNING INFORMATION**

## **SIMPLIFIED OUTLINE**

## **SYMBOL**

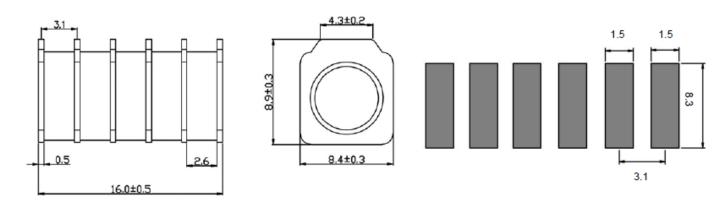






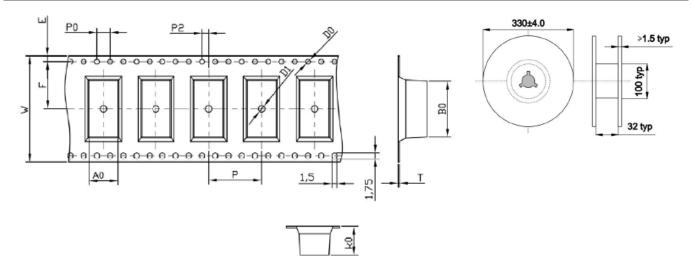
# **PACKAGE INFORMATION**

## **DIMENSION: Millimetre (mm)**



Tin-plated Recommended Pad Size

# **PACKAGE - REEL**



<	W	A0	В0	КО	E	F	Р	P0	P2	D0/1	Т
AT	32.00	8.80	16.90	9.40	1.75	14.2	16.00	4.00	2.00	1.50	0.50
	±0.30	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.10	±0.05

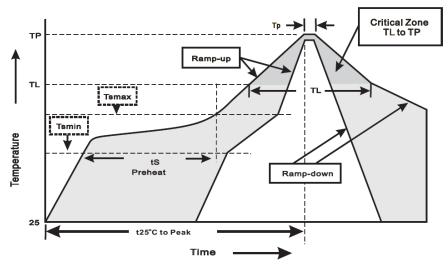
**Quantity:** 250pcs/reel **Colour:** Dark Blue



# **SOLDERING PARAMETERS**

## SUGGESTED THERMAL PROFILES FOR SOLDERING PROCESSES

- 1. Storage environment: Temperature=5 °C~40 °C Humidity=55% ±25%
- 2. Reflow soldering of surface-mount devices



#### 3. Reflow soldering

PROFILE FEATURE	SOLDERING CONDITION Pb-Free Assembly
Average ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )	<3 °C/sec
Preheat	
- Temperature Min (T <sub>smin</sub> )	150 °C
- Temperature Max (T <sub>smax</sub> )	200 °C
- Time (min to max) (t₅)	60 ~ 180 sec
T <sub>smax</sub> to T <sub>L</sub>	
- Ramp-upRate	<3 °C/sec
Time maintained above:	
- Temperature (T <sub>L</sub> )	217 °C
- Time(tL)	60 ~ 150 sec
Peak Temperature (T <sub>P</sub> )	255 °C-0/+5 °C
Time within 5 °C of actual Peak	20 ~ 40 sec
Temperature(tP)	
Ramp-down Rate	<6 °C/sec
Time 25 °C to Peak Temperature	<8 minutes



#### **CUSTOMER NOTE:**

#### **DISCLAIMER**

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- 1. ALPINESEMI™ Semiconductor Devices are RoHS compliant and hence customers are requested to dispose as per the prevailing Environmental Legislation put forth in their specific country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).



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